

Attorney Docket No.: 071469-0305914  
Client Reference No.: RAJ-007

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re PATENT APPLICATION of : Confirmation No.: 7364  
TSUKASA MATSUDA et al. : Group Art Unit: 1762  
Appln. No.: 10/673,910 : Examiner: STOUFFER, Kelly M.  
Filed: September 30, 2003 :  
FOR: METHOD FOR DEPOSITING METAL LAYERS USING SEQUENTIAL FLOW  
DEPOSITION

May 25, 2007

**AMENDMENT**

Mail Stop Amendment  
United States Patent and Trademark Office  
Customer Service Window  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314

Sir:

In response to the Final Office Action dated March 20, 2007, please amend the above-captioned patent application as follows: